

Product specifications

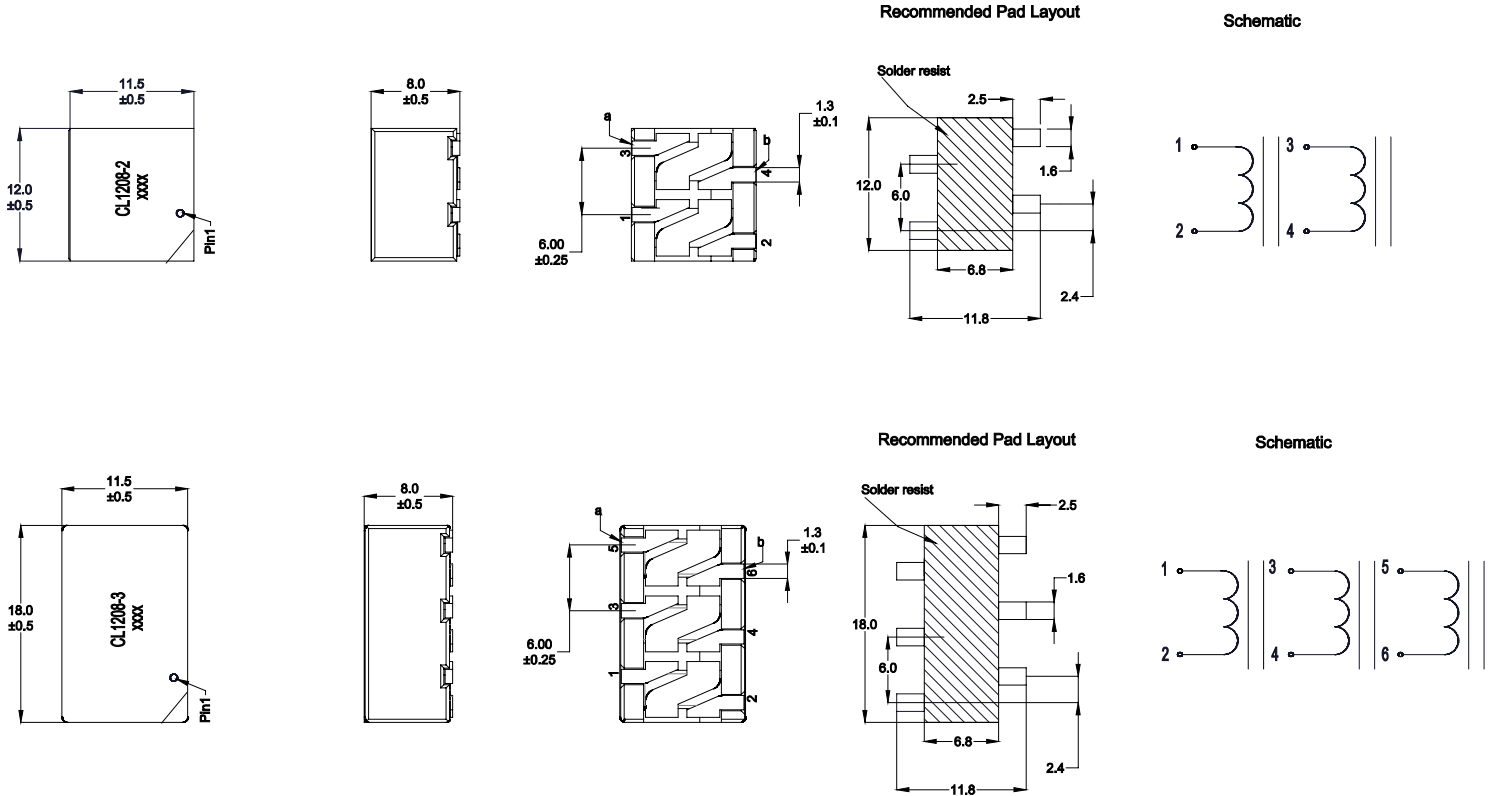
Part Number ⁵	Inductor Phases	OCL ¹ (nH) typical	OCL ¹ (nH) minimum	FLL ² (nH) minimum	I _{sat} ^{1,2} (A)	DCR (mΩ) maximum @ +20 °C	SCL ³ (nH) ±20%	I _{sat} ^{2,4} (A)
CL1208-2- 100TR-R	2	400	360	320	15	0.45	100	56
CL1208-3- 100TR-R	3	400	360	320	15	0.45	100	56
CL1208-4- 100TR-R	4	400	360	320	15	0.45	100	56
CL1208-6- 100TR-R	6	400	360	320	15	0.45	100	56

- Open Circuit Inductance (OCL) Test Parameters: 1.0 MHz, 0.1 V_{rms}, 0.0 Adc, +105 °C
- Full Load Inductance (FLL) Test Parameters: 1.0 MHz, 0.1 V_{rms}, I_{sat}¹, +105 °C
- Short Circuit Inductance (SCL) Test Parameters: 1.0 MHz, 0.1 V_{rms}, 0.0 Adc, +105 °C
CL1208-2-100TR-R short (1 & 4), measure (2 & 3), and divide by 2
CL1208-3-100TR-R short (1 & 4), (3 & 6), measure (2 & 5), and divide by 3
CL1208-4-100TR-R short (1 & 4), (3 & 6), (5 & 8) measure (2 & 7), and divide by 4
CL1208-6-100TR-R short (1 & 4), (3 & 6), (5 & 8), (7 & 10), (9 & 12) measure (2 & 11), and divide by 6
- I_{sat}²: Peak current where SCL drops approximately 20% @ +105 °C

- Part Number Definition: CL1208-x-100TR-R
CL1208 = Product code and size
x= Number of phases
100= Inductance value per phase in nH
TR= Tape and reel packaging
-R suffix = RoHS compliant

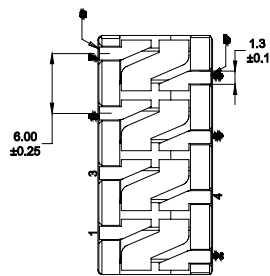
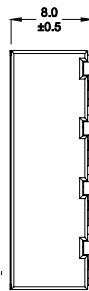
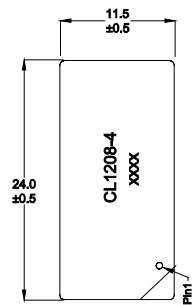
Note: This device is licensed for use only when incorporated within a voltage regulator employing power regulating devices manufactured by Maxim Integrated Devices, Inc. No license is granted expressly or by implication to use this device with power regulating devices manufactured by any company other than Maxim.

Dimensions (mm)

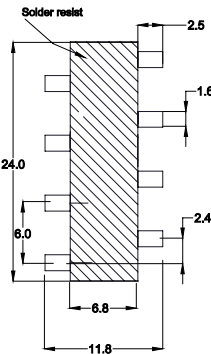


Part marking: CL1208-x (x = number of phases), xxxx = lot code
Tolerances are ±0.25 millimeters unless stated otherwise
All soldering surfaces to be coplanar within 0.13 millimeters
PCB tolerances are ±0.1 millimeters unless stated otherwise
DCR measured from point "a" to point "b"
Do not route traces or vias underneath the inductor

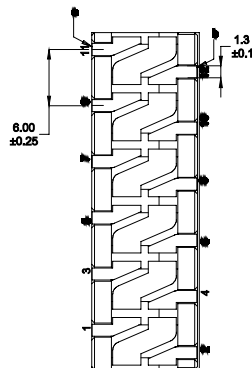
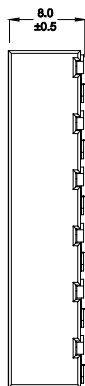
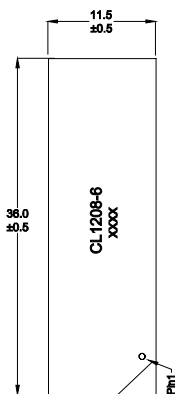
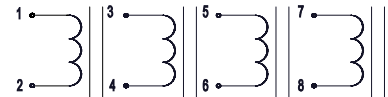
Dimensions (mm)



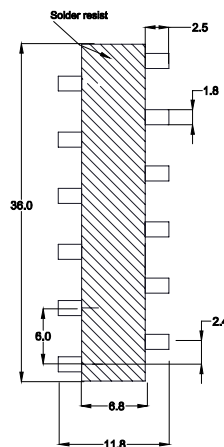
Recommended Pad Layout



Schematic



Recommended Pad Layout



Schematic



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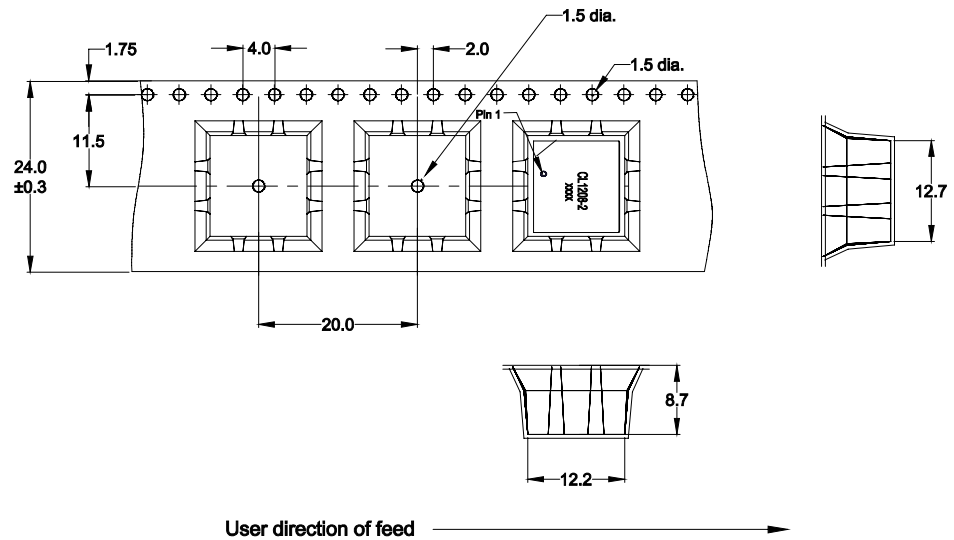
Packaging information (mm)

Supplied in tape and reel packaging on a 13" diameter reel

Drawing not to scale

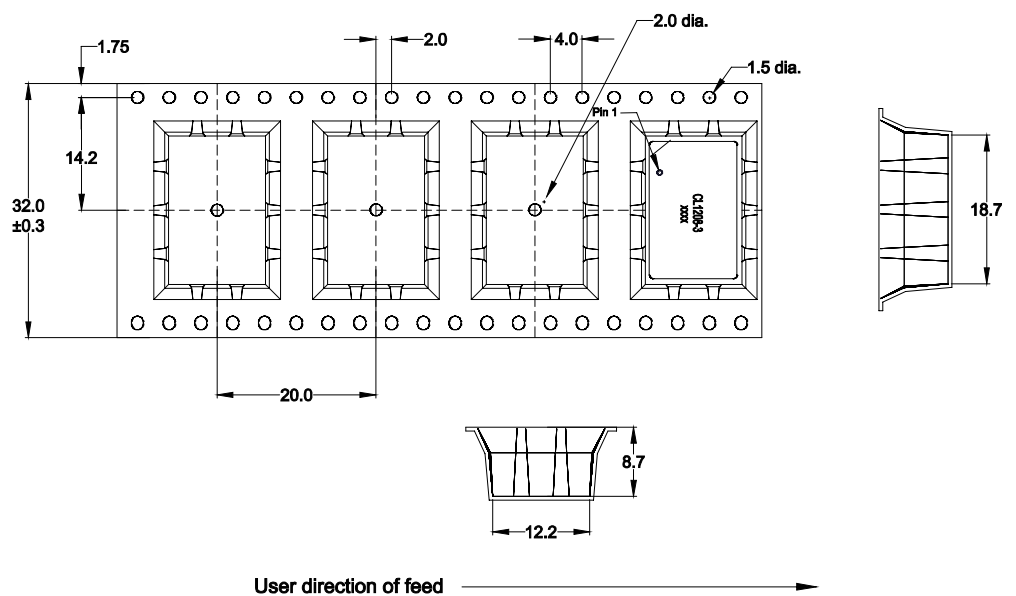
CL1208-2-100TR-R

300 parts per reel



CL1208-3-100TR-R

300 parts per reel



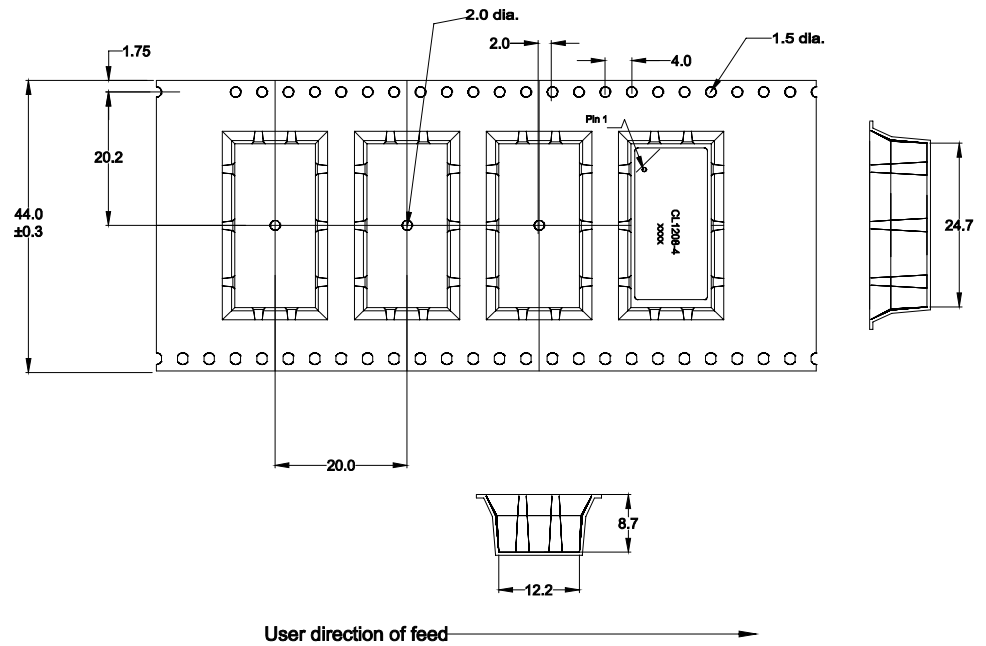
Packaging information (mm)

Supplied in tape and reel packaging on a 13" diameter reel

Drawing not to scale

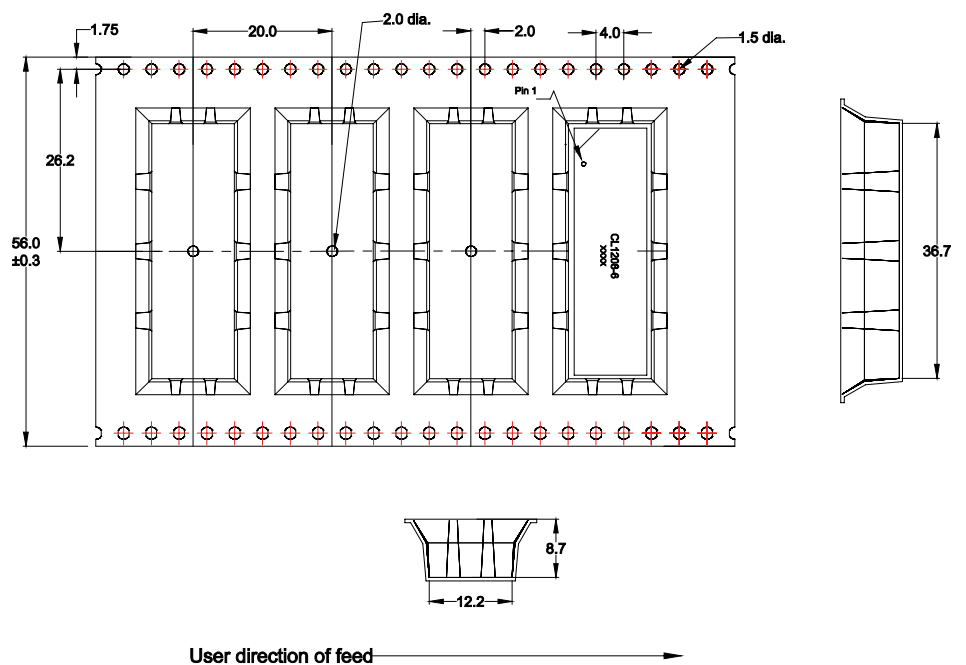
CL1208-4-100TR-R

200 parts per reel

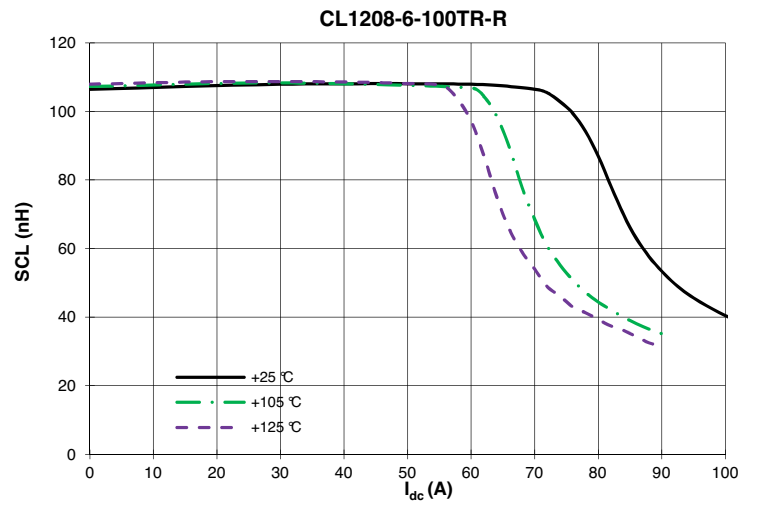
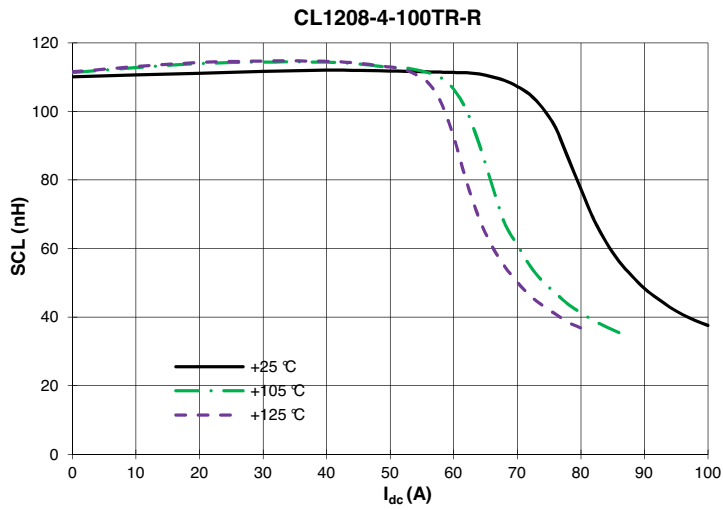
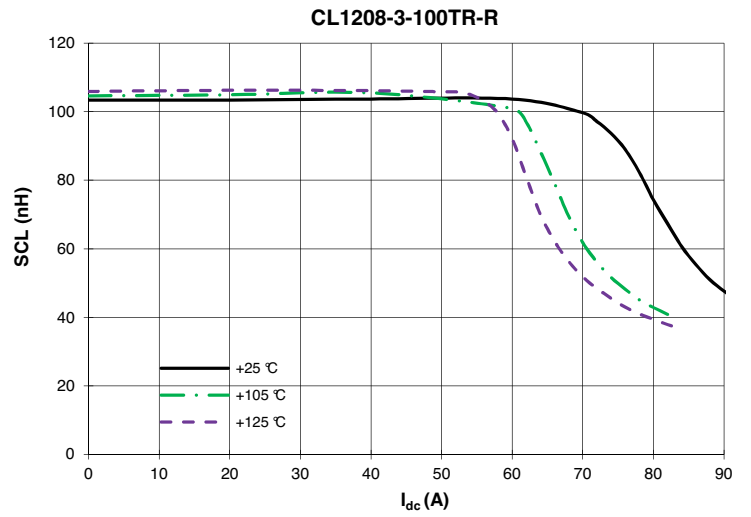
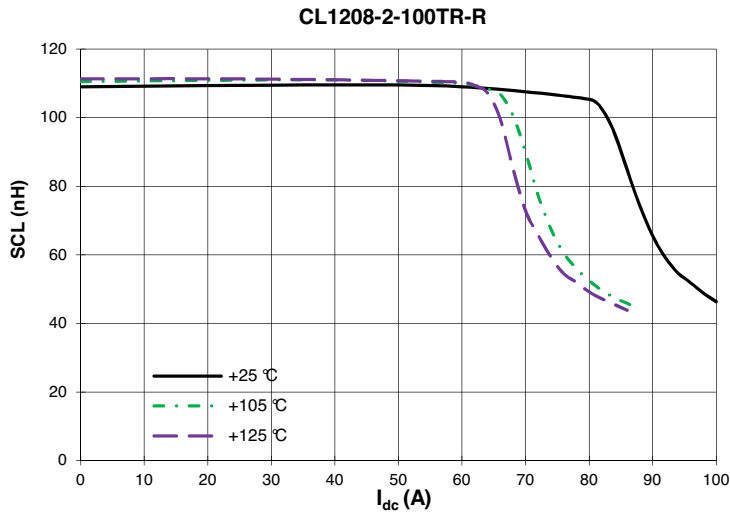


CL1208-6-100TR-R

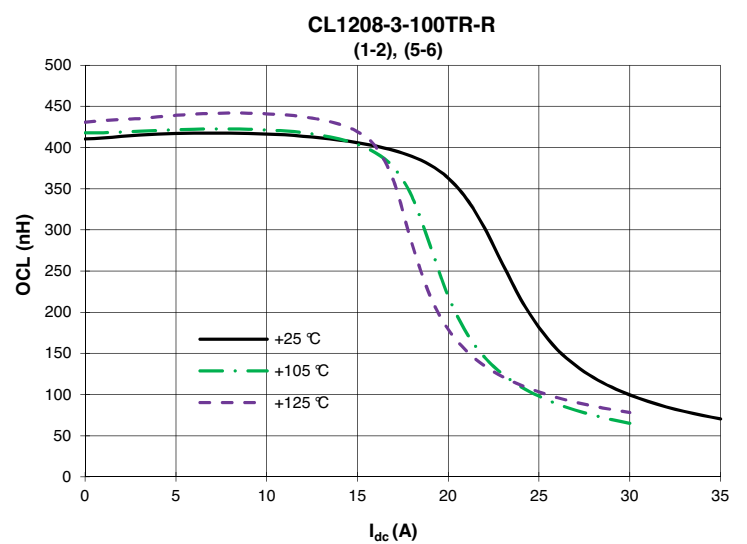
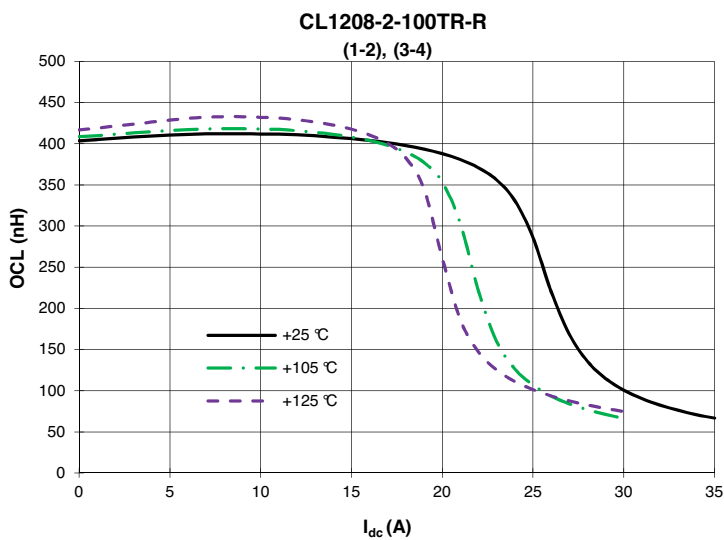
200 parts per reel



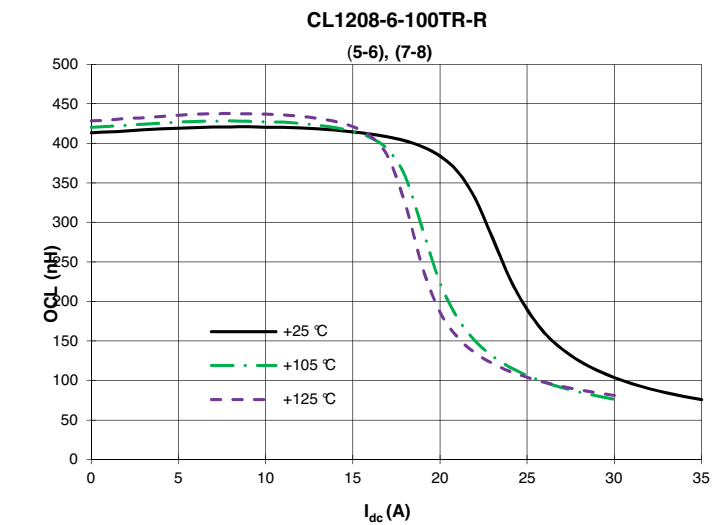
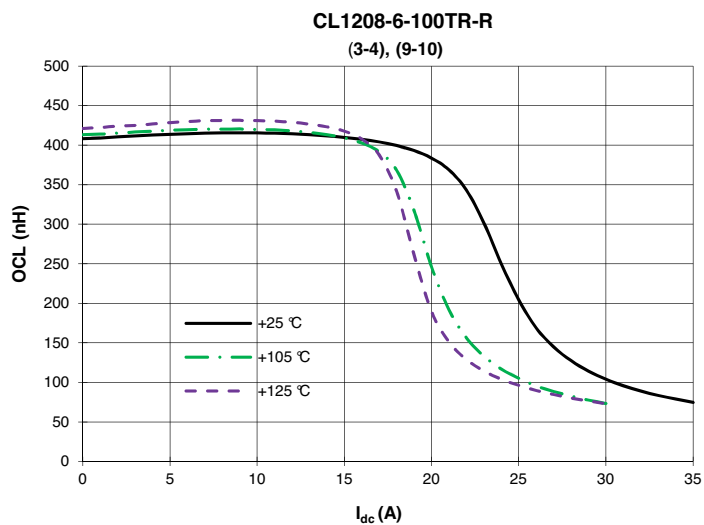
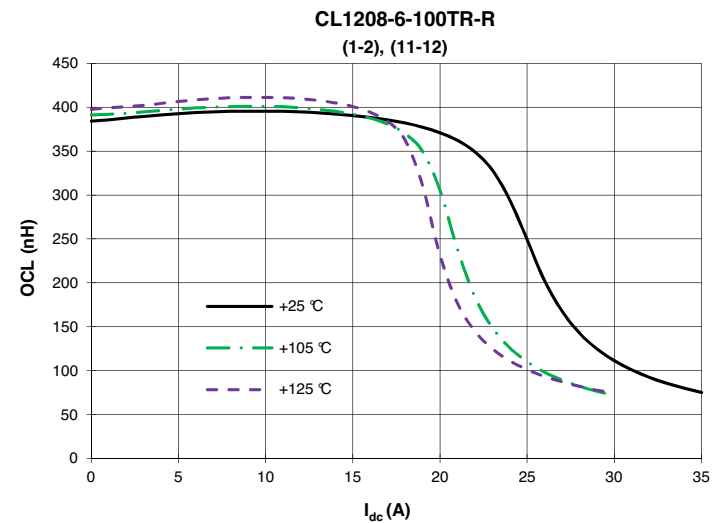
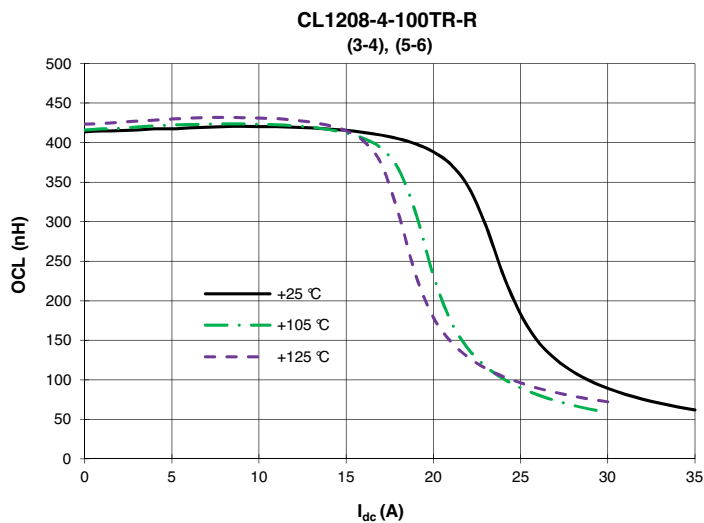
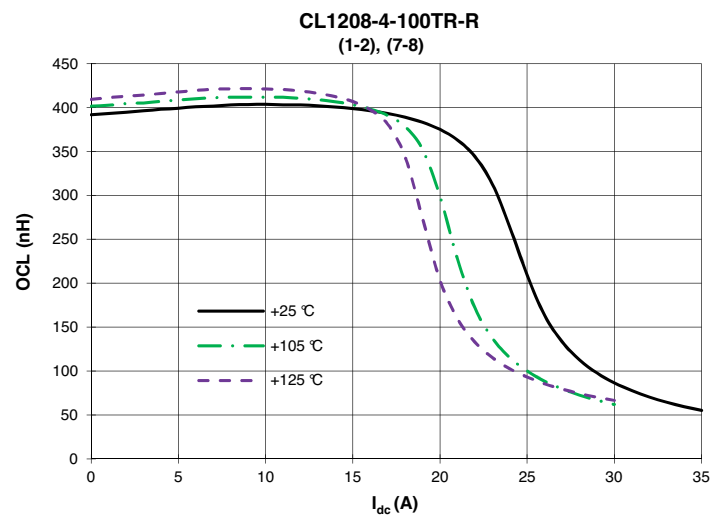
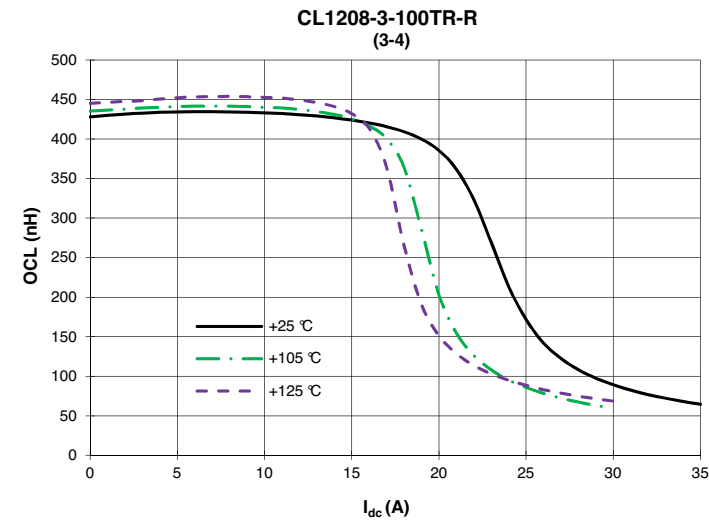
Inductance characteristics – SCL vs. current



Inductance characteristics – OCL vs. current



Inductance characteristics – OCL vs. current



Solder reflow profile

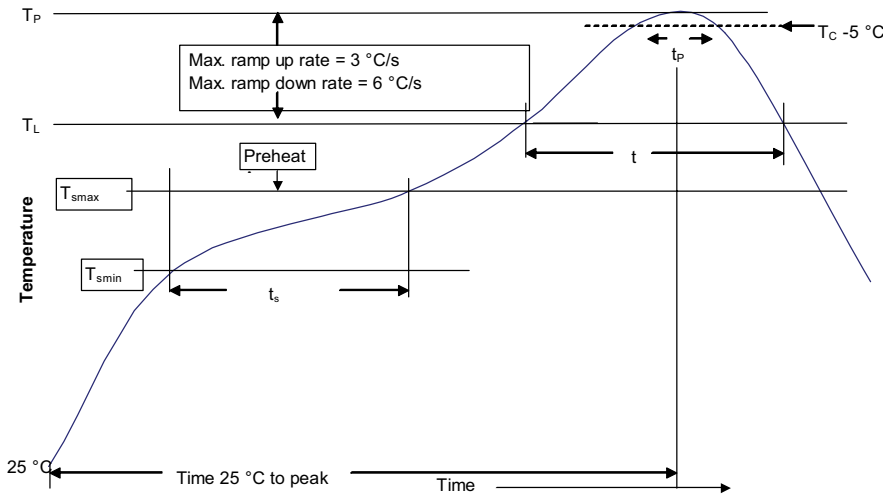


Table 1 - Standard SnPb Solder (T_c)

Package Thickness	Volume mm^3 <350	Volume mm^3 ≥ 350
<2.5 mm	235 °C	220 °C
≥ 2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) Free Solder (T_c)

Package Thickness	Volume mm^3 <350	Volume mm^3 350 - 2000	Volume mm^3 >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference JDEC J-STD-020

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak		
• Temperature min. (T_{smin})	100 °C	150 °C
• Temperature max. (T_{smax})	150 °C	200 °C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_p	3°C/ Second Max.	3 °C/ Second Max.
Liquidous temperature (T_L)	183 °C	217 °C
Time at liquidous (t_L)	60-150 Seconds	60-150 Seconds
Peak package body temperature (T_p)*	Table 1	Table 2
Time (t_p)** within 5 °C of the specified classification temperature (T_c)	20 Seconds**	30 Seconds**
Average ramp-down rate (T_p to T_{smax})	6 °C/ Second Max.	6 °C/ Second Max.
Time 25 °C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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Eaton
Electronics Division
1000 Eaton Boulevard
Cleveland, OH 44122
United States
www.eaton.com/electronics

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